

PART NUMBER

93L14DMB-ROCV

Rochester Electronics

Manufactured Components

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Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-38535
 - Class Q Military
 - Class V Space Level

Qualified Suppliers List of Distributors (QSLD)

- Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OCM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

93L14

93L14 Quad Latch



Literature Number: SNOS390A

93L14 Quad Latch

General Description

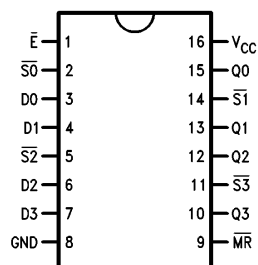
The 93L14 is a multifunctional 4-bit latch designed for general purpose storage applications in high speed digital systems. All outputs have active pull-up circuitry to provide high capacitance drive and to provide low impedance in both logic states for good noise immunity.

Features

- Can be used as single input D latches or set/reset latches
- Active low enable gate input
- Overriding master reset

Connection Diagram

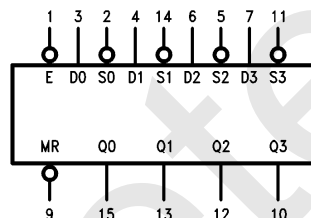
Dual-In-Line Package



TL/F/9612-1

Order Number 93L14DMQB or 93L14FMQB
See NS Package Number J16A or W16A

Logic Symbol



V_{CC} = Pin 16
GND = Pin 8

TL/F/9612-2

Pin Names	Description
\bar{E}	Enable Input (Active LOW)
D0–D3	Data Inputs
$\bar{S}0$ – $\bar{S}3$	Set Inputs (Active LOW)
\bar{MR}	Master Reset Input (Active LOW)
Q0–Q3	Latch Outputs

Absolute Maximum Ratings (Note)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	7V
Input Voltage	5.5V
Operating Free Air Temperature Range	
MIL	−55°C to +125°C
Storage Temperature Range	−65°C to +150°C

Note: The “Absolute Maximum Ratings” are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the “Electrical Characteristics” table are not guaranteed at the absolute maximum ratings. The “Recommended Operating Conditions” table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	93L14 (MIL)			Units
		Min	Nom	Max	
V _{CC}	Supply Voltage	4.5	5	5.5	V
V _{IH}	High Level Input Voltage	2			V
V _{IL}	Low Level Input Voltage			0.7	V
I _{OH}	High Level Output Voltage			−400	μA
I _{OL}	Low Level Output Current			4.8	mA
T _A	Free Air Operating Temperature	−55		125	°C
t _s (H)	Setup Time HIGH or LOW	10			ns
t _s (L)	D _n to \bar{E}	20			
t _h (H)	Hold Time HIGH or LOW	0			ns
t _h (L)	D _n to \bar{E}	10			
t _s (H)	Setup Time HIGH, D _n to \bar{S}_n	15			ns
t _h (L)	Hold Time LOW, D _n to \bar{S}_n	5			ns
t _w (L)	\bar{E} Pulse Width LOW	30			ns
t _w (L)	\bar{MR} Pulse Width LOW	25			ns
t _{rec}	Recovery Time, \bar{MR} to \bar{E}	5			ns

Electrical Characteristics

Over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 1)	Max	Units
V_I	Input Clamp Voltage	$V_{CC} = \text{Min}, I_I = -10 \text{ mA}$			-1.5	V
V_{OH}	High Level Output Voltage	$V_{CC} = \text{Min}, I_{OH} = \text{Max}, V_{IL} = \text{Max}, V_{IH} = \text{Min}$	2.4			V
V_{OL}	Low Level Output Voltage	$V_{CC} = \text{Min}, I_{OL} = \text{Max}, V_{IH} = \text{Min}, V_{IL} = \text{Max}$			0.3	V
I_I	Input Current @ Max Input Voltage	$V_{CC} = \text{Max}, V_I = 5.5 \text{ V}$			1	mA
I_{IH}	High Level Input Current	$V_{CC} = \text{Max}, V_I = 2.4 \text{ V}$	Inputs		20	μA
			D_n		30	
I_{IL}	Low Level Input Current	$V_{CC} = \text{Max}, V_I = 0.3 \text{ V}$	Inputs		-400	μA
			D_n		-600	
I_{OS}	Short Circuit Output Current	$V_{CC} = \text{Max}$ (Note 2)	-2.5		-25	mA
I_{CC}	Supply Current	$V_{CC} = \text{Max}$ (Note 3)			16.5	mA

Note 1: All typicals are at $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$.

Note 2: Not more than one output should be shorted at a time, and the duration should not exceed one second.

Note 3: I_{CC} is measured with all outputs open and all inputs grounded.

Switching Characteristics

$V_{CC} = +5.0 \text{ V}$, $T_A = +25^\circ\text{C}$ (See Section 1 for waveforms and load configurations)

Symbol	Parameter	$C_L = 15 \text{ pF}$		Units
		Min	Max	
t_{PLH} t_{PHL}	Propagation Delay \bar{E} to Q_n		45 36	ns
t_{PLH} t_{PHL}	Propagation Delay D_n to Q_n		30 30	ns
t_{PLH}	Propagation Delay, \overline{MR} to Q_n		30	ns
t_{PHL}	Propagation Delay, \bar{S}_n to Q_n		33	ns

Functional Description

The 93L14 consists of four latches with a common active LOW Enable input and active LOW Master Reset input. When the Enable goes HIGH, data present in the latches is stored and the state of the latch is no longer affected by the \bar{S}_n and D_n inputs. The Master Reset when activated overrides all other input conditions forcing all latch outputs LOW. Each of the four latches can be operated in one of two modes:

D-TYPE-LATCH—For D-type operation the \bar{S} input of a latch is held LOW. While the common Enable is active the latch output follows the D input. Information present at the latch output is stored in the latch when the Enable goes HIGH.

SET/RESET LATCH—During set/reset operation when the common Enable is LOW a latch is reset by a LOW on the D input, and can be set by a LOW on the \bar{S} input if the D input is HIGH. If both \bar{S} and D inputs are LOW, the D input will dominate and the latch will be reset. When the Enable goes HIGH, the latch remains in the last state prior to disablement. The two modes of latch operation are shown in the Truth Table.

Truth Table

MR	\bar{E}	D	\bar{S}	Q_n	Operation
H	L	L	L	L	D Mode
H	L	H	L	L	
H	H	X	X	Q_{n-1}	
H	L	L	L	L	R/S Mode
H	L	H	L	H	
H	L	L	H	L	
H	L	H	H	Q_{n-1}	
H	H	X	X	Q_{n-1}	
L	X	X	X	L	RESET

H = HIGH Voltage Level

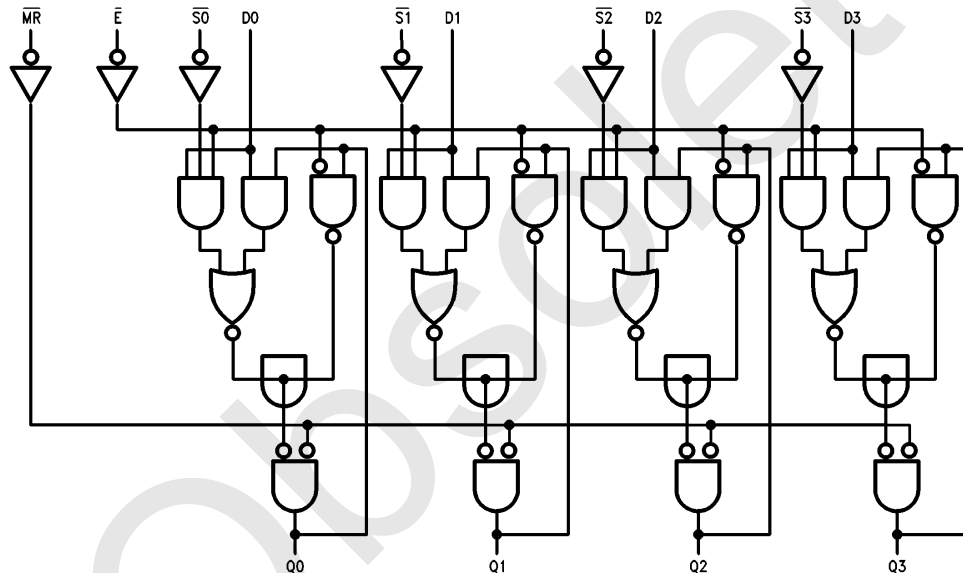
L = LOW Voltage Level

X = Immaterial

Q_{n-1} = Previous Output State

Q_n = Present Output State

Logic Diagram



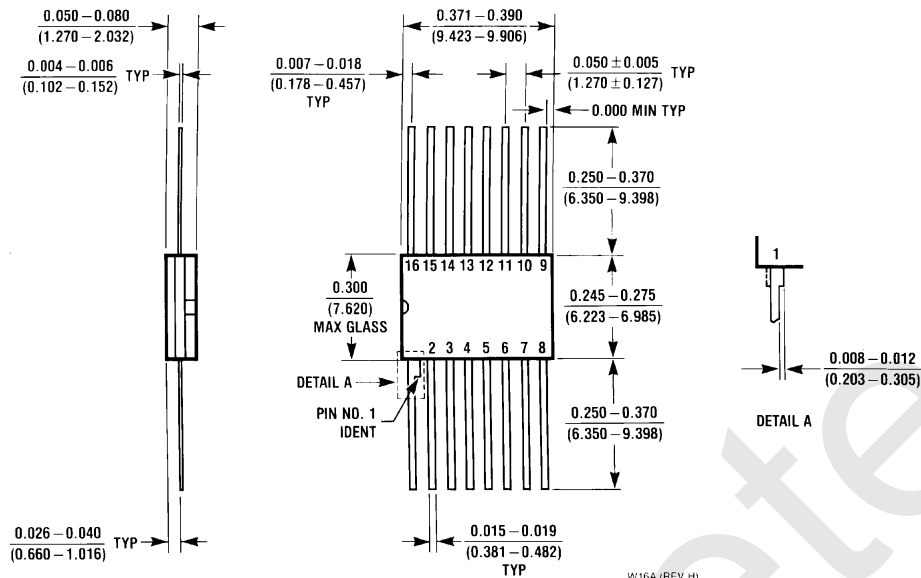
TL/F/9612-3

The image contains three mechanical drawings of the J16A package:

- Top View:** Shows the package with 16 pins. Dimensions include a total width of $0.785 [19.94]$ MAX, a pin pitch of $0.025 [0.64]$, and a pin diameter of $0.005-0.020 [0.13-0.51]$ TYP. Pin 1 is indicated on the left.
- Side View:** Shows the package height and pin dimensions. Dimensions include a total height of $0.220-0.310 [5.59-7.87]$, a pin height of $0.037 \pm 0.005 [0.94 \pm 0.13]$ TYP, and a pin diameter of $0.005 [0.13]$ MIN TYP. The pin angle is $90^\circ \pm 4^\circ$ TYP.
- Cross-sectional View:** Shows the package profile with dimensions including a total width of $0.290-0.320 [7.37-8.13]$, a pin height of $0.180 [4.57]$ MAX, and a pin angle of $95^\circ \pm 5^\circ$ TYP. The package is labeled "GLASS SEALANT".

Additional dimensions and tolerances are provided for various features, such as $0.010 \pm 0.002 [0.25 \pm 0.05]$ TYP for the pin diameter and $0.018 \pm 0.003 [0.46 \pm 0.08]$ TYP for the pin length.

16-Lead Ceramic Dual-In-Line Package (J)
Order Number 93L14DMQB
NS Package Number J16A

Physical Dimensions inches (millimeters) (Continued)

16-Lead Ceramic Flat Package (W)
Order Number 93L14FMQB
NS Package Number W16A

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